گروه فنی مهندسی جوش و برش مقدم



اعتماد از شما کیفیت و تخصص از ما

 \bigcirc

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مشهد خیام شمالی 63 خیابان پردیس 3

برای کسب اطلاعات بیشتر بر روی لینک ها کلیک کنید

- 7 سال سابقه آموزش تعمیرات تخصصی دستگاه های جوش اینورتری تک فاز و 3 فاز
- 7 سال سابقه فروش قطعات الكترونيكي دستگاه جوش
 تك فاز و 3 فاز
- آموزش تخصصی تحلیل دستگاه های جوش اینورتری مختص ابراز فروشان
 - آموزش تخصصی ابراز آلات شارژی

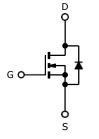


IRF740

RoHS

Power MOSFET

TO-220AB



N-Channel MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	400				
$R_{DS(on)}(\Lambda)$	$V_{GS} = 10 V$	0.55			
Q _g max. (nC)	63				
Q _{gs} (nC)	9.0				
Q _{gd} (nC)	32				
Configuration	Single				

FEATURES

- Dynamic dV/dt rating
- Repetitive avalanche rated
- Fast switching
- Ease of paralleling
- Simple drive requirements
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

Note

* This datasheet provides information about parts that are RoHScompliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRF740PbF
Lead (Pb)-free and halogen-free	IRF740PbF-BE3

ABSOLUTE MAXIMUM RATINGS (T _c = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	400	V		
Gate-source voltage			V _{GS}	± 20	v	
Continuous drain current	V _{GS} at 10 V	T _c = 25 °C	ID	10		
	VGS AL IU V	T _c = 100 °C	ID	6.3	A	
Pulsed drain current ^a			I _{DM}	40		
Linear derating factor				1.0	W/°C	
Single pulse avalanche energy ^b			E _{AS}	520	mJ	
Repetitive avalanche current ^a			I _{AR}	10	A	
Repetitive avalanche energy ^a			E _{AR} 13		mJ	
Maximum power dissipation	T _C =	25 °C	P _D 125		W	
Peak diode recovery dV/dt ^c			dV/dt	4.0	V/ns	
Operating junction and storage temperature range		TJ, T _{stg}	-55 to +150	°C		
Soldering recommendations (peak temperature) ^d	For 10 s			300		
Mounting torque	6-32 or M3 screw			10	lbf ' in	
				1.1	N ' m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 9.1 mH, R_g = 25 Λ , I_{AS} = 10 A (see fig. 12)

c. $I_{\text{SD}} \leq 10$ A, $dI/dt \leq 120$ A/µs, $V_{\text{DD}} \leq V_{\text{DS}}, \, T_{\text{J}} \leq 150$ °C

d. 1.6 mm from case

S21-0853-Rev. D, 16-Aug-2021

1



THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum junction-to-ambient	R _{thJA}	- 62 0.50 -						
Case-to-sink, flat, greased surface	R _{thCS}				°C/W			
Maximum junction-to-case (drain)	R _{thJC}	- 1.0						
SPECIFICATIONS (T _J = 25 °C, u	Inless otherwis	se noted)						
PARAMETER	SYMBOL	TEST	CONDITI	ONS	MIN.	TYP.	MAX.	UNIT
Static						1	1	
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0$	V, I _D = 2	50 µA	400	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_J$	Reference to	o 25 °C, 1	[_D = 1 mA	-	0.49	-	V/°C
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{C}$	_{ss} , I _D = 2	50 µA	2.0	-	4.0	V
Gate-source leakage	I _{GSS}	V _{GS}	$= \pm 20$	/	-	-	± 100	nA
7	Ŧ	$V_{DS} = 40$	00 V, V _{GS}	= 0 V	-	-	25	
Zero gate voltage drain current	I _{DSS}	V _{DS} = 320 V, V _{GS} = 0 V, T _J = 125 °C		-	-	250	μA	
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	ID	= 6.0 A ^b	-	-	0.55	Λ
Forward transconductance	9 _{fs}	V _{DS} = 50	$V, I_D = 6$	5.0 A ^b	5.8	-	-	S
Dynamic	•	•				•		
Input capacitance	C _{iss}	Ve	_{ss} = 0 V,		-	1400	-	
Output capacitance	C _{oss}	$V_{DS} = 25 V_{r}$		-	330	-	pF	
Reverse transfer capacitance	C _{rss}	f = 1.0	MHz, see	fig. 5	-	120	-	
Total gate charge	Qg				-	-	63	nC
Gate-source charge	Q _{gs}	$V_{GS} = 10 V$		A, $V_{DS} = 320 V$, g. 6 and 13 ^b	-	-	9.0	
Gate-drain charge	Q _{gd}		500 H	g. 0 and 15	-	-	32	
Turn-on delay time	t _{d(on)}				-	14	-	
Rise time	tr	V _{DD} = 20	00 V, I _D =	= 10 A	-	27	-	1
Turn-off delay time	t _{d(off)}	$R_g = 9.1 \Lambda$, $R_D = 20 \Lambda$, see fig. 10 ^b		-	50	-	ns	
Fall time	tr			-	24	-		
Gate input resistance	Rg	f = 1 MHz, open drain		0.8	-	5.9	Λ	
Internal drain inductance	Lo	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	nH	
Internal source inductance	Ls			-	7.5	-		
Drain-Source Body Diode Characteristic	cs					•	•	
Continuous source-drain diode current	Is	MOSFET symbol showing the integral reverse p - n junction diode		-	-	10	A	
Pulsed diode forward current ^a	I _{SM}			-	-	40		
Body diode voltage	V _{SD}	$T_{\rm J}$ = 25 °C, $I_{\rm S}$ = 10 A, $V_{\rm GS}$ = 0 V ^b		-	-	2.0	V	
Body diode reverse recovery time	t _{rr}	- $T_J = 25 \text{ °C}, I_F = 10 \text{ A}, dI/dt = 100 \text{ A}/\mu\text{s}^{\text{b}}$		-	370	790	ns	
Body diode reverse recovery charge	Q _{rr}			-	3.8	8.2	μC	
Forward turn-on time	t _{on}	Intrinsic turn-	on time	is negligible (turi	n-on is do	minated b	by L_s and	L _D)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width \leq 300 μs ; duty cycle \leq 2 %

2



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

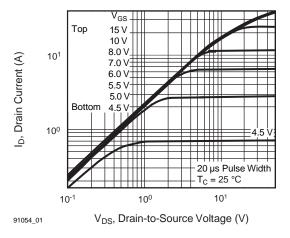
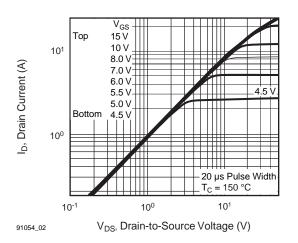
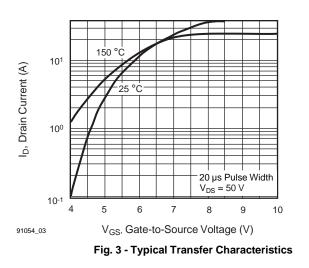


Fig. 1 - Typical Output Characteristics, T_c = 25 °C







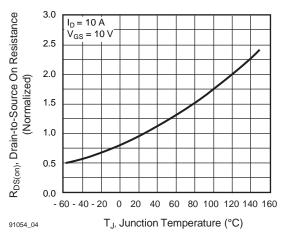


Fig. 4 - Normalized On-Resistance vs. Temperature

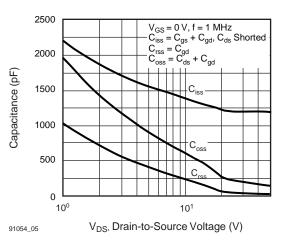


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

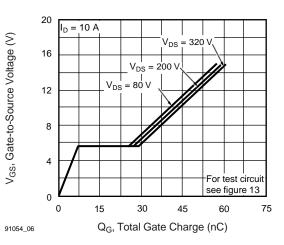


Fig. 6 - Typical Gate Charge vs. Drain-to-Source Voltage

S21-0853-Rev. D, 16-Aug-2021

3

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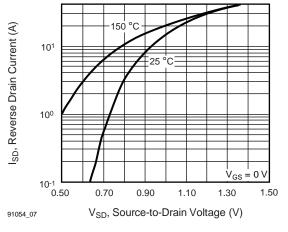


Fig. 7 - Typical Source-Drain Diode Forward Voltage

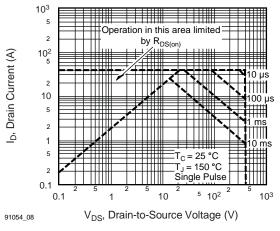


Fig. 8 - Maximum Safe Operating Area

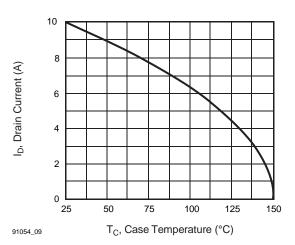


Fig. 9 - Maximum Drain Current vs. Case Temperature

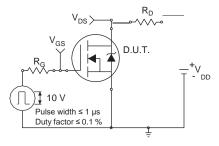


Fig. 10a - Switching Time Test Circuit

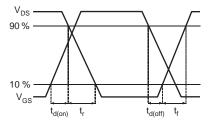
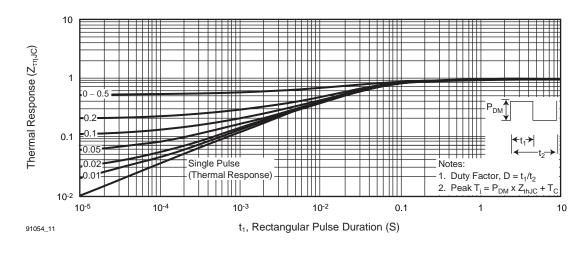


Fig. 10b - Switching Time Waveforms



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4

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Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

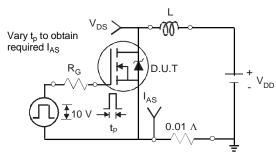


Fig. 12a - Unclamped Inductive Test Circuit

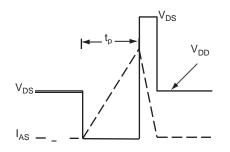


Fig. 12b - Unclamped Inductive Waveforms

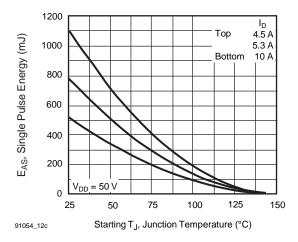


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

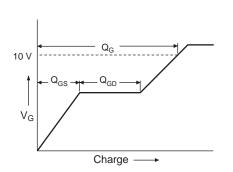


Fig. 13a - Basic Gate Charge Waveform

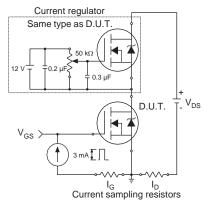


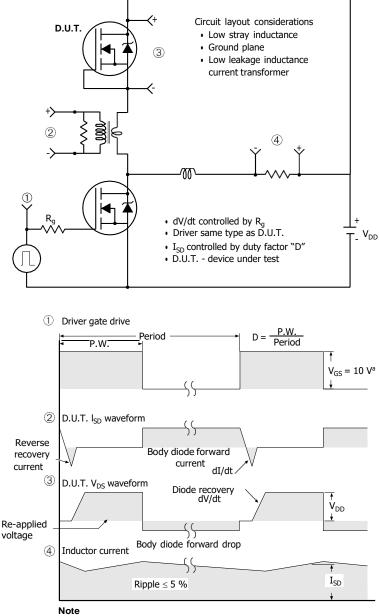
Fig. 13b - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 14 - For N-Channel

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